Very Low Supply Current 3-Pin Microprocessor Reset Monitor

The NCP803 is a cost-effective system supervisor circuit designed to monitor V_{CC} in digital systems and provide a reset signal to the host processor when necessary. No external components are required.

The reset output is driven active within 10 µsec of V_{CC} falling through the reset voltage threshold. Reset is maintained active for a minimum of 140 msec after V_{CC} rises above the reset threshold. The NCP803 has an open drain active-low RESET output. The output of the NCP803 is guaranteed valid down to $V_{CC} = 1.0 \text{ V}$ and is available in a SOT-23 package.

The NCP803 is optimized to reject fast transient glitches on the V_{CC} line. Low supply current of 1.0 μ A ($V_{CC} = 3.2 \text{ V}$) make this device suitable for battery powered applications.

Features

- Precision V_{CC} Monitor for 2.5 V, 3.0 V, 3.3 V, and 5.0 V Supplies
- Precision Monitoring Voltages from 1.6 V to 4.9 V Available in 100 mV Steps
- 140 msec Guaranteed Minimum RESET Output Duration
- RESET Output Guaranteed to $V_{CC} = 1.0 \text{ V}$
- Low 1.0 μA Supply Current
- V_{CC} Transient Immunity
- Small SOT-23 Package
- No External Components
- Wide Operating Temperature: -40°C to 105°C WWW.DZSC.COM

Typical Applications

- Computers
- Embedded Systems
- Battery Powered Equipment
- Critical µP Power Supply Monitoring

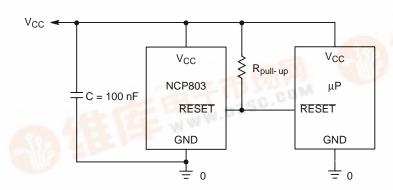
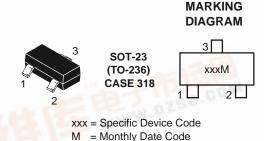


Figure 1. Typical Application Diagram

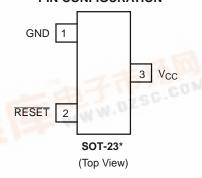


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PIN CONFIGURATION



NOTE: *SOT-23 is equivalent to JEDEC (TO-236)

ORDERING INFORMATION

Device	evice Package Shippir	
NCP803SNxxxT1	SOT-23	3000/Tape & Reel

NOTE: The "xxx" denotes a suffix for V_{cc} voltage threshold options - see page 6 for more details.

DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 6 of this data sheet.



PIN DESCRIPTION

Pin No.	Symbol	Description
1	GND	Ground
2	RESET	RESET output remains low while V_{CC} is below the reset voltage threshold, and for 240 msec (typ.) after V_{CC} rises above reset threshold.
3	V _{CC}	Supply Voltage: C = 100 nF is recommended as a bypass capacitor between V _{CC} and GND.

ABSOLUTE MAXIMUM RATINGS* (Note 1)

Rating	Symbol	Value	Unit
Supply Voltage (V _{CC} to GND)	V _{CC}	6.0	V
RESET		-0.3 to (V _{CC} + 0.3)	V
Input Current, V _{CC}		20	mA
Output Current, RESET		20	mA
dV/dt (V _{CC})		100	V/μsec
Thermal Resistance, Junction to Air	$R_{ heta JA}$	491	°C/W
Operating Temperature Range	T _A	-40 to +105	°C
Storage Temperature Range	T _{stg}	-65 to +150	°C
Lead Temperature (Soldering, 10 Seconds)	T _{sol}	+260	°C
Latch-up performance: Negative	I _{Latch- up}	150	mA

$$P_D = \frac{T_J(max) - T_A}{P_{O,J,A}} \quad \text{with } T_{J(max)} = 150^{\circ}C$$

^{*}Maximum Ratings are those values beyond which damage to the device may occur.

1. This device series contains ESD protection and exceeds the following tests:
 Human Body Model 4000 V per MIL-STD-883, Method 3015.
 Machine Model Method 400 V.

2. The maximum package power dissipation limit must not be exceeded.

PD = TJ(max) - TA/RθJA with TJ(max) = 150°C

ELECTRICAL CHARACTERISTICS $T_A = -40^{\circ}\text{C}$ to $+105^{\circ}\text{C}$ unless otherwise noted. Typical values are at $T_A = +25^{\circ}\text{C}$. (Note 3)

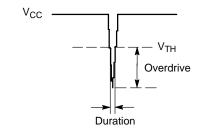
Characteristic	Symbol	Min	Тур	Max	Unit
V _{CC} Range					V
$T_A = 0$ °C to +70°C		1.0	-	5.5	
$T_A = -40$ °C to +105°C		1.2	-	5.5	
Supply Current	I _{CC}				μА
V _{CC} = 3.3 V	.00				p
$T_A = -40$ °C to +85°C		_	0.5	1.2	
$T_A = 85^{\circ}\text{C to } + 105^{\circ}\text{C}$		_	-	2.0	
V _{CC} = 5.5 V					
$T_A = -40$ °C to +85°C		-	0.8	1.8	
$T_A = 85^{\circ}\text{C to } +105^{\circ}\text{C}$		-	-	2.5	
Reset Threshold (Note 4)	V _{TH}				V
NCP803SN463					
$T_A = +25^{\circ}C$		4.56	4.63	4.70	
$T_A = +2.5 \text{ C}$ $T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}$		4.51	4.03		
			-	4.75	
$T_A = +85^{\circ}C \text{ to } +105^{\circ}C$		4.39	-	4.87	
NCP803SN438					
$T_A = +25^{\circ}C$		4.31	4.38	4.45	
$T_A = -40$ °C to $+85$ °C		4.27	-	4.49	
$T_A = +85^{\circ}C \text{ to } +105^{\circ}C$		4.16	-	4.60	
NCP803SN308					
T _A = +25°C		3.04	3.08	3.11	
$T_A = -40$ °C to +85°C		3.00	-	3.15	
$T_A = +85^{\circ}C \text{ to } +105^{\circ}C$		2.92	_	3.23	
1A = 100 0 to 1100 0		2.02		0.20	
NCP803SN293					
$T_A = +25^{\circ}C$		2.89	2.93	2.96	
$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		2.85	-	3.00	
$T_A = +85^{\circ}C \text{ to } +105^{\circ}C$		2.78	-	3.08	
NCP803SN263					
T _A = +25°C		2.59	2.63	2.66	
$T_A = -40$ °C to +85°C		2.55	-	2.70	
$T_A = +85^{\circ}\text{C to } +105^{\circ}\text{C}$		2.50	_	2.76	
1A = 100 0 to 1100 0		2.00		2.70	
NCP803SN232					
$T_A = +25$ °C		2.29	2.32	2.35	
$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		2.26	-	2.38	
$T_A = +85^{\circ}C$ to $+105^{\circ}C$		2.20	=	2.44	
NCP803SN160					
$T_A = +25^{\circ}C$		1.58	1.60	1.62	
$T_A = -40$ °C to +85°C		1.56	-	1.64	
$T_A = +85^{\circ}C \text{ to } +105^{\circ}C$		1.52	-	1.68	
Reset Temperature Coefficient		-	30	-	ppm/°C
V _{CC} to Reset Delay V _{CC} = V _{TH} to (V _{TH} - 100 mV)		-	10	-	μsec
Reset Active Timeout Period		140	240	460	msec
RESET Output Voltage Low	V _{OL}	-	-	0.3	V
$V_{CC} = V_{TH} - 0.2 \text{ V}$					
$1.6 \text{ V} \leq \text{V}_{TH} \leq 2.0 \text{ V}, \text{I}_{SINK} = 0.5 \text{ mA}$					
$2.1 \text{ V} \leq \text{V}_{TH} \leq 4.0 \text{ V}, \text{I}_{SINK} = 1.2 \text{ mA}$					
$4.1 \text{ V} \leq \text{V}_{TH} \leq 4.9 \text{ V}, \text{I}_{SINK} = 3.2 \text{ mA}$					
RESET Leakage Current	I _{LEAK}	-	-	1	μΑ
$V_{CC} > V_{TH}$, RESET De-asserted					

Production testing done at T_A = 25°C, over temperature limits guaranteed by design.
 Contact your ON Semiconductor sales representative for other threshold voltage options.

APPLICATIONS INFORMATION

V_{CC} Transient Rejection

The NCP803 provides accurate $V_{\rm CC}$ monitoring and reset timing during power-up, power-down, and brownout/sag conditions, and rejects negative-going transients (glitches) on the power supply line. Figure 2 shows the maximum transient duration vs. maximum negative excursion (overdrive) for glitch rejection. Any combination of duration and overdrive which lies **under** the curve will **not** generate a reset signal. Combinations above the curve are detected as a brownout or power-down. Typically, transient that goes 100 mV below the reset threshold and lasts 5 μ s or less will not cause a reset pulse. Transient immunity can be improved by adding a capacitor in close proximity to the $V_{\rm CC}$ pin.



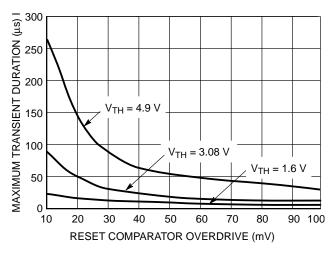


Figure 2. Maximum Transient Duration vs. Overdrive for Glitch Rejection at 25°C

Processors With Bidirectional I/O Pins

Some μP 's (such as Motorola 68HC11) have bi-directional reset pins which interface easily with the Open Drain \overline{RESET} output of the NCP803. As shown in Figure 3, one can connect directly to the \overline{RESET} output of the NCP803 to the \overline{RESET} pin of the μP . The pull-up resistor avoids an undetermined voltage of the \overline{RESET} pin.

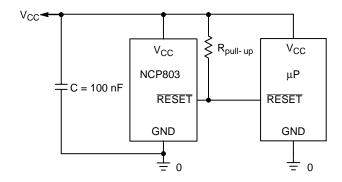


Figure 3. Interfacing to Bidirectional Reset I/O

NCP803 RESET Output Allows Use With Two Power Supplies

In numerous applications the pull-up resistor placed on the \overline{RESET} output is connected to the supply voltage monitored by the IC. Nevertheless, a different supply voltage can also power this output and so level-shift from the monitored supply to reset the μP . However, if the NCP803's supply goes below 1 V, the \overline{RESET} output ability to sink current will decrease and the result is a high state on the pin even though the supply's IC is under the threshold level. This occurs at a V_{CC} level that depends on the $R_{pull-up}$ value and the voltage to which it is connected.

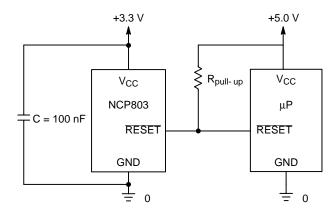


Figure 4. RESET Output with Two Power Supplies

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TYPICAL CHARACTERISTICS

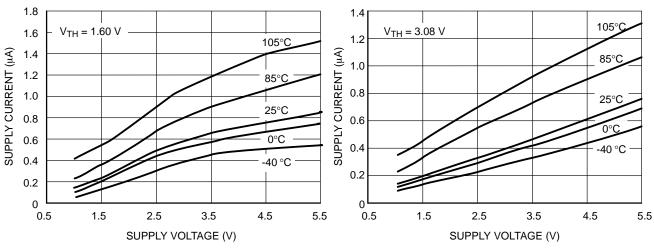


Figure 5. Supply Current vs. Supply Voltage

Figure 6. Supply Current vs. Supply Voltage

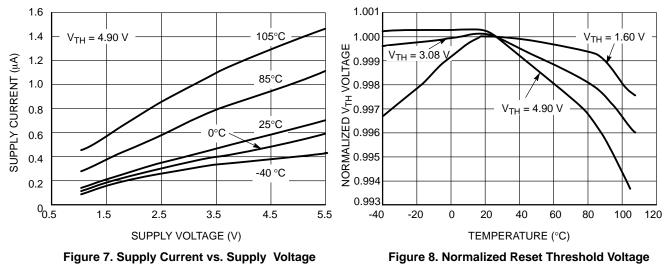


Figure 7. Supply Current vs. Supply Voltage

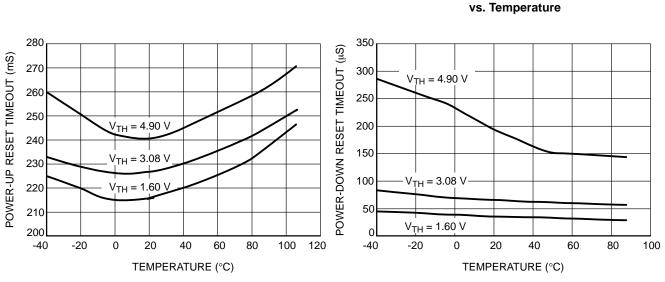
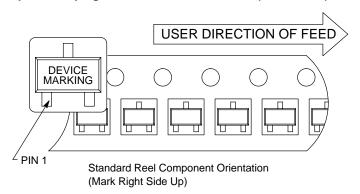


Figure 9. Power-up Reset Timeout vs. Temperature

Figure 10. Power-down Reset Timeout vs. Temperature (Overdrive = 20 mV)

TAPING FORM

Component Taping Orientation for 3L SOT-23 (JEDEC-236) Devices



Tape & Reel Specifications Table

Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
SOT-23	8 mm	4 mm	3000	7 inches

MARKING AND THRESHOLD INFORMATION

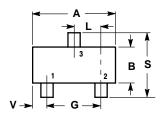
ON Semiconductor Part #	V _{TH} *	Marking (Note 5)
NCP803SN160T1	1.60	SCQM
NCP803SN232T1	2.32	SQRM
NCP803SN263T1	2.63	SQCM
NCP803SN293T1	2.93	SQDM
NCP803SN308T1	3.08	SQEM
NCP803SN438T1	4.38	SQFM
NCP803SN463T1	4.63	SQGM

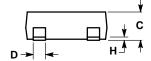
^{*}Contact your ON Semiconductor sales representative for other threshold voltage options.

5. M = Monthly Date Code

PACKAGE DIMENSIONS

SOT-23 PLASTIC PACKAGE (TO-236) CASE 318-08 ISSUE AH







- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
 4. 318-03 AND -07 OBSOLETE, NEW STANDARD 318-08.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.1102	0.1197	2.80	3.04	
В	0.0472	0.0551	1.20	1.40	
С	0.0350	0.0440	0.89	1.11	
D	0.0150	0.0200	0.37	0.50	
G	0.0701	0.0807	1.78	2.04	
Н	0.0005	0.0040	0.013	0.100	
J	0.0034	0.0070	0.085	0.177	
K	0.0140	0.0285	0.35	0.69	
L	0.0350	0.0401	0.89	1.02	
S	0.0830	0.1039	2.10	2.64	
٧	0.0177	0.0236	0.45	0.60	

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